Effective June 2017 Supersedes December 2008

# FP1006 High frequency, high current power inductors



#### **Product features**

- 10.2 x 8.0 x 6.0mm surface mount package
- Ferrite core material
- High current carrying capacity, Low core losses
- Controlled DCR tolerance for sensing circuits
- Inductance range from 85nH to 220nH
- Current range from 38 to 100 amps
- Frequency range up to 2MHz

### Applications

- Multi-phase regulators
- Voltage Regulator Module (VRM)
- Point-of-load modules
- Desktop and server VRMs and EVRDs
- Data networking and storage systems
- Graphics cards and battery power systems
- DCR sensing

#### **Environmental data**

- Storage temperature range (component): -40 °C to +125 °C
- Operating temperature range: -40 °C to +125 °C (ambient plus self-temperature rise)
- Solder reflow temperature: J-STD-020 (latest revision) compliant





|                |                             |                            | Produc                   | t Specifications                  |                                    |                 |          |
|----------------|-----------------------------|----------------------------|--------------------------|-----------------------------------|------------------------------------|-----------------|----------|
| Part Number    | OCL <sup>1</sup> ± 10% (nH) | FLL <sup>2</sup> Min. (nH) | I <sub>rms</sub> ³ (Amps | I <sub>sat</sub> 1⁴ @ 25°C (Amps) | I <sub>sat</sub> 2⁵ @ 125°C (Amps) | DCR (mΩ) @ 20°C | K-factor |
| R1 Version     |                             |                            |                          |                                   |                                    |                 |          |
| FP1006R1-R08-R | 85                          | 61                         |                          | 100                               | 70                                 |                 | 454      |
| FP1006R1-R10-R | 100                         | 72                         |                          | 85                                | 64                                 |                 | 454      |
| FP1006R1-R12-R | 120                         | 86                         | 53                       | 71                                | 53                                 | 0.27 ± 12%      | 454      |
| FP1006R1-R16-R | 160                         | 115                        |                          | 55                                | 40                                 |                 | 454      |
| FP1006R1-R22-R | 220                         | 158                        |                          | 38                                | 28                                 |                 | 454      |
| R2 Version     |                             |                            |                          |                                   |                                    | -               |          |
| FP1006R2-R08-R | 85                          | 61                         |                          | 100                               | 70                                 |                 | 454      |
| FP1006R2-R10-R | 100                         | 72                         |                          | 85                                | 64                                 |                 | 454      |
| FP1006R2-R12-R | 120                         | 86                         | 45                       | 71                                | 53                                 | 0.36 ± 8.6%     | 454      |
| FP1006R2-R16-R | 160                         | 115                        |                          | 55                                | 40                                 |                 | 454      |
| FP1006R2-R22-R | 220                         | 158                        |                          | 38                                | 28                                 |                 | 454      |

1 Open Circuit Inductance (OCL) Test Parameters: 100kHz, 0.10Vrms, 0.0Adc

2 Full Load Inductance (FLL) Test Parameters: 100kHz, 0.1Vrms, Isat1

3~ I\_{rms}: DC current for an approximate temperature rise of 40°C without core loss. Derating is necessary for AC currents. PCB pad layout, trace thickness and width, air-flow and proximity of other heat generating components will affect the temperature rise. It is recommended the part temperature not exceed 125°C under worst case operating conditions verified in the end application.

4  $I_{sat}$ 1: Peak current for approximately 20% rolloff at +25°C.

5 Isat2: Peak current for approximately 20% rolloff at +125°C.

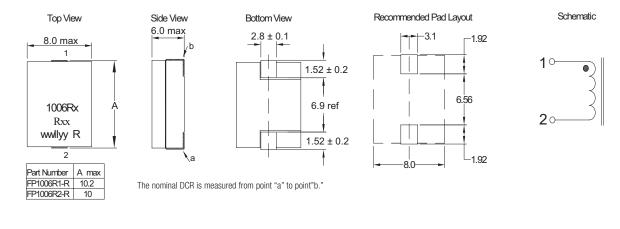
6 K-factor: Used to determine  $B_{p-p}$  for core loss (see graph).  $B_{p-p} = K * L * \Delta I * 10^{-3}$ ,  $B_{p-p}$ : (Gauss), K: (K-factor from table), L: (inductance in nH), ∆I (peak-to-peak ripple current in amps).

7 Part Number Definition: FP1006Rx-Rxx-R

• Rx is the DCR indicator

• FP1006 = Product code and size • Rxx= Inductance value in  $\mu$ H, R = decimal point • "-R" suffix = RoHS compliant

## **Dimensions- mm**



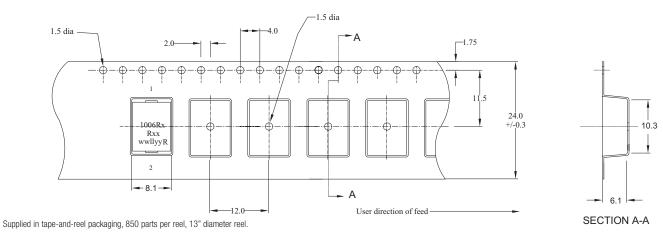
Part Marking:

1006Rx (Rx = DCR Indicator) Rxx = Inductance value in  $\mu H$ . (R = Decimal point)

wwllyy = Date code

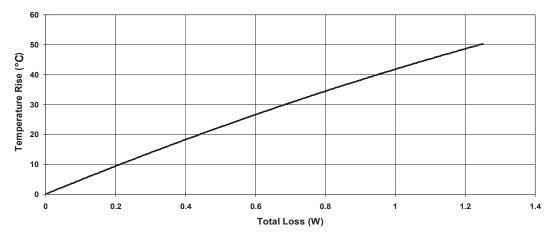
R = Revision level

# **Packaging information - mm**

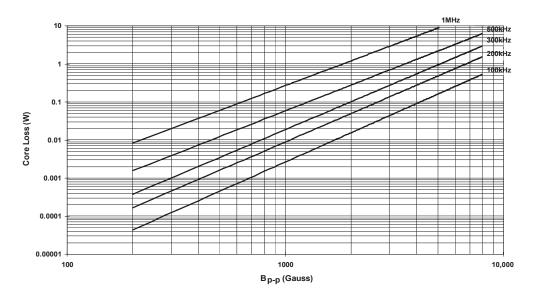


# FP1006 High frequency, high current power inductor

# Temperature rise vs total loss

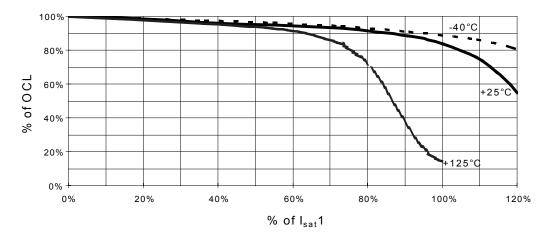


# Core loss vs Bp-p

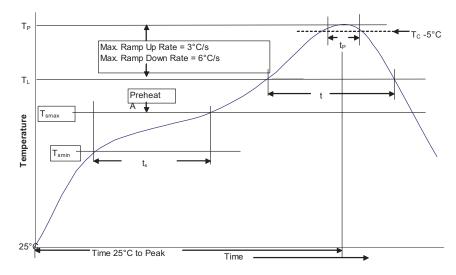


# Inductance characteristics

% of OCL vs. % of  $I_{sat}\,1$ 



# **Solder Reflow Profile**



| Table 1 - Star           | ndard SnF  | Pb Solder (T <sub>C</sub> )             |                           |
|--------------------------|--|---|---------------------------|
|                          | Volume   | Volume                                  |                           |
| Package                  | mm <sup>3</sup>  | mm <sup>3</sup>                         |                           |
| Thickness                | <350   | ≥350                                    |                           |
| <2.5mm                   | 235°C  | 220°C                                   |                           |
| ≥2.5mm                   | 220°C  | 220°C                                   |                           |
|                          |  |   |                           |
| Table 2 - Lea            | d (Pb) Fre   | e Solder (T <sub>C</sub> )              |                           |
| Table 2 - Lea            | d (Pb) Fre<br>Volume   | e Solder (T <sub>C</sub> )<br>Volume    | Volume                    |
| Table 2 - Lea<br>Package |  | •••                                     | Volume<br>mm <sup>3</sup> |
|                          | Volume   | Volume                                  |                           |
| Package                  | Volume<br>mm <sup>3</sup>  | Volume<br>mm <sup>3</sup>               | mm <sup>3</sup>           |
| Package<br>Thickness     | <b>Volume</b><br><b>mm</b> <sup>3</sup><br><b>&lt;350</b><br>260°C | Volume<br>mm <sup>3</sup><br>350 - 2000 | mm <sup>3</sup> >2000     |

# **Reference JDEC J-STD-020**

Powerina Business Worldwide

| Profile Feature   |   | Standard SnPb Solder | Lead (Pb) Free Solder<br>150°C |  |
|---|---|----------------------|--------------------------------|--|
| Preheat and Soak  | <ul> <li>Temperature min. (T<sub>smin</sub>)</li> </ul>                         | 100°C                |                                |  |
|   | <ul> <li>Temperature max. (T<sub>smax</sub>)</li> </ul>                         | 150°C                | 200°C                          |  |
|   | <ul> <li>Time (T<sub>smin</sub> to T<sub>smax</sub>) (t<sub>s</sub>)</li> </ul> | 60-120 Seconds       | 60-120 Seconds                 |  |
| Average ramp up rate T <sub>smax</sub> to T <sub>p</sub>                                  |   | 3°C/ Second Max.     | 3°C/ Second Max.               |  |
| Liquidous temperature (TL)  |   | 183°C                | 217°C                          |  |
| Time at liquidous (t <sub>L</sub> )   |   | 60-150 Seconds       | 60-150 Seconds                 |  |
| Peak package body temperature (T <sub>P</sub> )*  |   | Table 1              | Table 2                        |  |
| Time $(t_p)^{\star\star}$ within 5 °C of the specified classification temperature $(T_c)$ |   | 20 Seconds**         | 30 Seconds**                   |  |
| Average ramp-down rate (Tp to Tsmax)  |   | 6°C/ Second Max.     | 6°C/ Second Max.               |  |
| Time 25°C to Peak Temperature   |   | 6 Minutes Max.       | 8 Minutes Max.                 |  |

 $^{\star}$  Tolerance for peak profile temperature (T\_p) is defined as a supplier minimum and a user maximum.

\*\* Tolerance for time at peak profile temperature  $(t_p)$  is defined as a supplier minimum and a user maximum.

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